



Integrated
Circuit
Systems, Inc.

ICS84330-03

700MHz, Low JITTER, CRYSTAL-TO-3.3V DIFFERENTIAL LVPECL FREQUENCY SYNTHESIZER

GENERAL DESCRIPTION



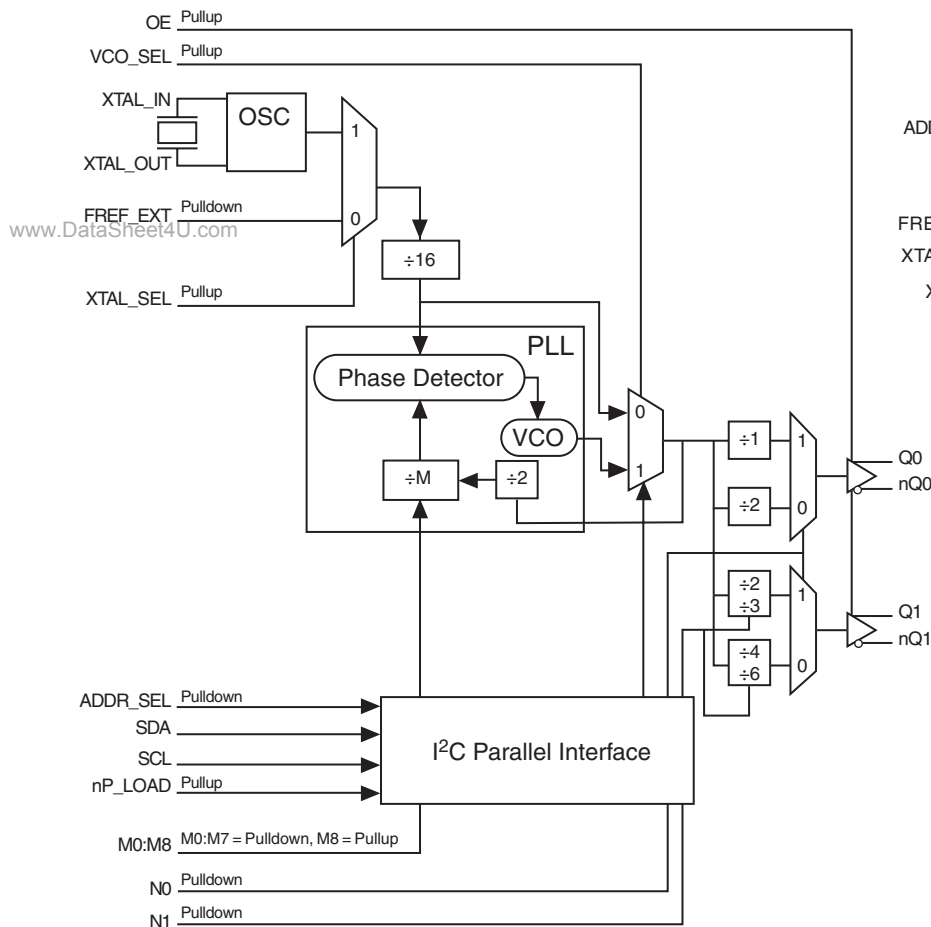
The ICS84330-03 is a general purpose, dual output high frequency synthesizer and a member of the HiPerClockS™ family of High Performance Clock Solutions from ICS. The VCO operates at a frequency range of 250MHz to 700MHz. The VCO and output frequency can be programmed using the I²C interface. The output can be configured to divide the VCO frequency by 1, 2, 3, 4, and 6.

Additionally, the device supports spread spectrum clocking (SSC) for minimizing Electromagnetic Interference (EMI). The low cycle-cycle jitter and broad frequency range of the ICS84330-03 make it an ideal clock generator for a variety of demanding applications which require high performance.

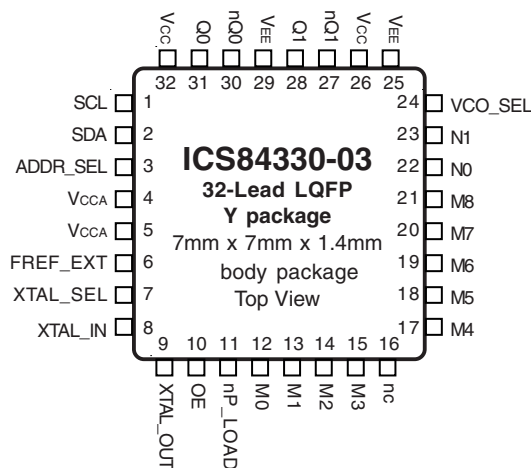
FEATURES

- Fully integrated PLL, no external loop filter requirements
- Two differential 3.3V LVPECL output
- Crystal oscillator interface: 10MHz to 25MHz
- Output frequency range: 41.67MHz to 700MHz
- VCO range: 250MHz to 700MHz
- Parallel or I²C interface for programming M and N dividers during power-up
- Supports Spread Spectrum Clocking (SSC)
Center spread: selectable $\pm 0.5\%$, $\pm 1.0\%$, $\pm 1.5\%$, $\pm 2\%$
Up/Down spread: selectable 0.5%, 1.0%, 1.5%, 2%, 2.5%, 3%, 3.5%, 4%
- RMS Period jitter: 9ps (maximum)
- Cycle-to-cycle jitter: 40ps (maximum)
- 3.3V supply voltage
- 0°C to 70°C ambient operating temperature
- Industrial temperature information available upon request
- Available in both standard and lead-free RoHS-compliant packages

BLOCK DIAGRAM



PIN ASSIGNMENT





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The ICS84330-03 uses either a parallel interface or industry standard I²C interface to control the programming of the internal dividers. The power on defaults are summarized as follows:

Parallel Mode: **M** **Output**
 256 Q0/nQ0 output at 267MHz
 (using a 16.667MHz crystal)
 Q1/nQ1 output at 133MHz
 (using a 16.667MHz crystal)

SSC Mode: Off

The programming mode is controlled by the nP_LOAD pin. When this pin is low, The M, N values are set by the logic values on the M, N pins. If nP_LOAD is HIGH, the M, N dividers can be changed using the I²C serial programming interface.

The I²C control registers are defined below:

Data Byte 0

Control Bit	N1	N0	M8	M7	M6	M5	M4	M3
Power-up Default Value	0	0	1	0	0	0	0	0

Data Byte 1

Control Bit	M2	M1	M0	Not Used	Not Used	Not Used	Not Used	Not Used
Power-up Default Value	0	0	0	X	X	X	X	X

Data Byte 2

Control Bit	Up	Down	SSC5	SSC4	SSC3	SSC2	SSC1	SSC0
Power-up Default Value	0	0	0	0	0	0	0	0

I²C ADDRESSING

The ICS84330-03 can be set to decode one of two addresses to minimize the chance of address conflict on the I²C bus. The

address that is decoded is controlled by the setting of the ADDR_SEL pin (pin 3).

ADDR_SEL (pin 3) = 0 Default							
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
1	1	0	1	1	0	0	R/W

ADDR_SEL (pin 3) = 1							
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
1	1	0	1	1	1	0	R/W

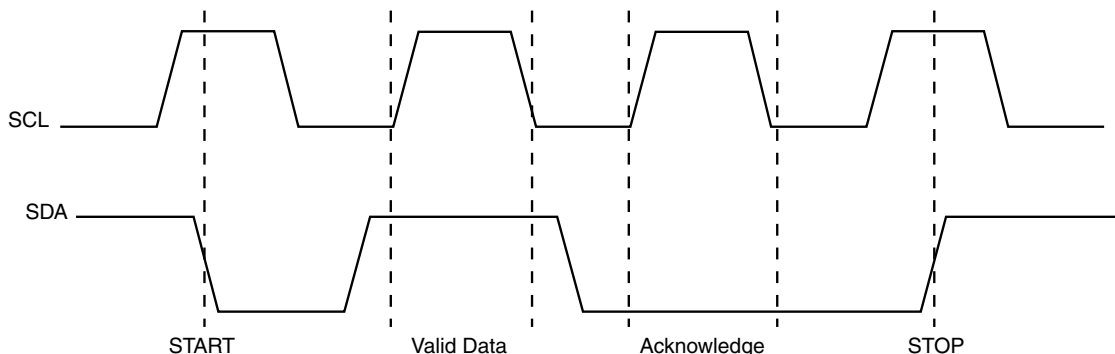


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I²C INTERFACE - PROTOCOL

The ICS84330-03 is a slave-only device and uses the standard I²C protocol as shown in the below diagrams. The maximum SCL frequency is greater than 10MHz which is more than sufficient for standard I²C clock speeds.



START (ST) – defined as high-to-low transition on SDA while holding SCL HIGH.

DATA - Between START and STOP cycles, SDA is synchronous with SCL. Data may change only when SCL is LOW and must be stable when SCL is HIGH.

ACKNOWLEDGE (AK) – SDA is driven LOW before the SCL rising edge and held LOW until the SCL falling edge.

STOP (SP) – defined as low-to-high transition on SDA while holding SCL HIGH.

I²C INTERFACE - A WRITE EXAMPLE

A serial transfer to the ICS84330-03 always consists of an address cycle followed by 4 data bytes: 1 dummy byte followed by 3 data bytes. Any additional bytes beyond the 4 data bytes will not be acknowledged and the ICS84330-03 will leave the data bus HIGH. These extra bits will not be loaded into the serial control register. Once the 4 Data bytes are loaded

and the master generates a stop condition, the values in the serial control register are latched into the M divider, N divider, and control bits and the device will smoothly slew to the new frequency and any changes to the state of the control bits will take effect.

ST	Slave Address: 7 Bits	R/W	AK
1 Bit	Refer to page 2 for address choices based on ADDR_SEL pin setting	1 Bit	1 Bit

Dummy Byte 0: 8 Bits	AK
	1 Bit

Data Byte 0: 8 Bits								AK
N1	N0	M8	M7	M6	M5	M4	M3	1 Bit

Data Byte 1: 8 Bits								AK
M2	M1	M0	Not Used	Not Used	Not Used	Not Used	Not Used	1 Bit

Data Byte 2: 8 Bits								AK	SP
Up	Down	SSC5	SSC4	SSC3	SSC2	SSC1	SSC0	1 Bit	1 Bit

↑
Data Byte values latched into control registers here.



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SPREAD SPECTRUM OPERATION

NOTE: The functional description that follows used a 16.6667MHz crystal with an M divide value of 160.

Spread Spectrum operation is controlled by I²C Data Byte 2, Spread Spectrum Control Register. Bits SSC0 – SSC5 (SS) of the register are a subtrahend to the M-divider for down-spread, and they are an addend and a subtrahend to the M-divider for center-spread. When the UP bit is HIGH, then up-spread has been selected and the M-divider value will toggle between the programmed M value, and M+SS at a 32kHz rate. When the DN bit is HIGH, then down-spread

has been selected and the M-divider value will toggle between the programmed M value, and M-SS at a 32kHz rate. When both the UP and DN bits are HIGH, then center-spread has been selected and the M-divider will toggle between M+SS and M-SS at a 32kHz rate. The table below shows the desired SS value to achieve 0.5%, 1% and 1.5% spread at selected VCO frequencies. To disable Spread Spectrum operation, program both the UP and DN bits to LOW. Spread Spectrum operation will also be disabled when the nP_LOAD input is LOW.

TABLE 1A. SS MODE FUNCTION TABLE

Register Bits		SS Mode
SSC7	SSC6	
0	0	Off
0	1	Down-Spread
1	0	Up-Spread
1	1	Center-Spread

TABLE 1B. UP/DOWN SPREAD CONFIGURATION

Up- or Down-Spread SS Value						Spread %
SSC5	SSC4	SSC3	SSC2	SSC1	SSC0	
0	0	0	0	0	1	0.50
0	0	0	1	0	0	1.00
0	0	0	1	1	0	1.50
0	0	1	0	0	0	2.00
0	0	1	0	1	0	2.50
0	0	1	1	0	0	3.00
0	0	1	1	1	0	3.50
0	1	0	0	0	0	4.00

TABLE 1C. CENTER SPREAD CONFIGURATION

Center-Spread SS Value						Spread (±) %
SSC5	SSC4	SSC3	SSC2	SSC1	SSC0	
0	0	0	0	0	1	0.50
0	0	0	1	0	0	1.00
0	0	0	1	1	0	1.50
0	0	1	0	0	0	2.00



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FUNCTIONAL DESCRIPTION

NOTE: The functional description that follows describes operation using a 16.6667MHz crystal. Valid PLL loop divider values for different crystal or input frequencies are defined in the Input Frequency Characteristics, Table 7, NOTE 1.

The ICS84330-03 features a fully integrated PLL and therefore requires no external components for setting the loop bandwidth. A quartz crystal is used as the input to the on-chip oscillator. The output of the oscillator is divided by 16 prior to the phase detector.

The phase detector and the M divider force the VCO output frequency to be 2M times the reference frequency by adjusting the VCO control voltage. Note that for some values of M (either too high or too low), the PLL will not achieve lock. The output of the VCO is scaled by a divider prior to being sent to each of the LVPECL output buffers. The divider provides a 50% output duty cycle.

The programmable features of the ICS84330-03 support two input modes to program the M divider and N output divider. The two input operational modes are parallel and I²C. Figure 1 shows the timing diagram for parallel mode. In parallel mode the nP_LOAD input is LOW. The data on inputs M0 through M8 and N0 through N1 is passed directly to the M divider and N output divider. On the LOW-to-HIGH transition of the nP_LOAD input, the data is latched and the M divider remains loaded until the next LOW transition on nP_LOAD or until an I²C event occurs. The relationship between the VCO frequency, the crystal frequency and the M divider is defined as follows: $f_{VCO} = \frac{f_{xtal}}{16} \times 2M$

The M value and the required values of M0 through M8 are shown in Table 3B, Programmable VCO Frequency Function Table. Valid M values for which the PLL will achieve lock are defined as $120 \leq M \leq 336$. The frequency out is defined as follows: $f_{out} = \frac{f_{VCO}}{N} = \frac{f_{xtal}}{16} \times \frac{2M}{N}$

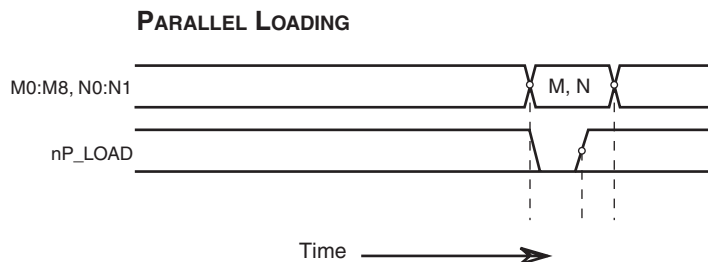


FIGURE 1. PARALLEL LOAD OPERATIONS



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TABLE 2. PIN DESCRIPTIONS

Number	Name	Type		Description
1	SCL	Input	NOTE 1	I ² C serial clock input.
2	SDA	Input	NOTE 1	I ² C serial data input.
3	ADDR_SEL	Input	Pulldown	Serial address select pin. LVCMOS / LVTTTL interface levels.
4, 5	V _{CCA}	Power		Analog supply pin.
6	FREF_EXT	Input	Pulldown	PLL reference input. LVCMOS / LVTTTL interface levels.
7	XTAL_SEL	Input	Pullup	Selects between the crystal oscillator or FREF_EXT inputs as the PLL reference source. Selects XTAL inputs when HIGH. Selects FREF_EXT when LOW. LVCMOS / LVTTTL interface levels.
8, 9	XTAL_IN, XTAL_OUT	Input		Crystal oscillator interface. XTAL_IN is an oscillator input. XTAL_OUT is an oscillator output.
10	OE	Input	Pullup	Output enable. LVCMOS / LVTTTL interface levels.
11	nP_LOAD	Input	Pullup	Parallel load input. Determines when data present at M8:M0 is loaded into M divider, and when data present at N1:N0 sets the N output divide value. LVCMOS / LVTTTL interface levels.
12, 13, 14, 15, 17, 18, 19, 20	M0, M1, M2 M3, M4, M5 M6, M7	Input	Pulldown	M divider inputs. Data latched on LOW-to-HIGH transition of nP_LOAD input. LVCMOS / LVTTTL interface levels.
21	M8	Input	Pullup	
16	nc	Unused		No connect.
22, 23	N0, N1	Input	Pulldown	Determines N output divider value as defined in Table 4B Function Table. LVCMOS / LVTTTL interface levels.
24	VCO_SEL	Input	Pullup	When logic LOW, bypass PLL. When logic HIGH, PLL is active. LVCMOS/LVTTTL interface levels.
25, 29	V _{EE}	Power		Negative supply pins.
26, 32	V _{CC}	Power		Core supply pins.
27, 28	nQ1, Q1	Output		Differential clock outputs. LVPECL interface levels.
30, 31	nQ0, Q0	Output		Differential clock outputs. LVPECL interface levels.

NOTE: *Pullup* and *Pulldown* refer to internal input resistors. See Table 3, Pin Characteristics, for typical values.

NOTE 1: Pullup resistor is only active in parallel mode.

TABLE 3. PIN CHARACTERISTICS

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C _{IN}	Input Capacitance			4		pF
R _{PULLUP}	Input Pullup Resistor			51		kΩ
R _{PULLDOWN}	Input Pulldown Resistor			51		kΩ



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TABLE 4A. PROGRAMMABLE VCO FREQUENCY FUNCTION TABLE

VCO Frequency (MHz)	M Divide	256	128	64	32	16	8	4	2	1
		M8	M7	M6	M5	M4	M3	M2	M1	M0
250	120	0	0	1	1	1	1	0	0	0
252	121	0	0	1	1	1	1	0	0	1
254	122	0	0	1	1	1	1	0	1	0
256	123	0	0	1	1	1	1	0	1	1
•	•	•	•	•	•	•	•	•	•	•
•	•	•	•	•	•	•	•	•	•	•
696	334	1	0	1	0	0	1	1	1	0
698	335	1	0	1	0	0	1	1	1	1
700	336	1	0	1	0	1	0	0	0	0

NOTE 1: These M divide values and the resulting frequencies correspond to a crystal frequency of 16.6667MHz.

TABLE 4B. PROGRAMMABLE OUTPUT DIVIDER FUNCTION TABLE

Inputs		Outputs	
N1	N0	Q0/nQ0	Q1/nQ1
0	0	÷2	÷4
0	1	÷1	÷2
1	0	÷2	÷6
1	1	÷1	÷3



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ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V_{CC}	4.6V
Inputs, V_i	-0.5V to $V_{CC} + 0.5V$
Outputs, I_o	
Continuous Current	50mA
Surge Current	100mA
Package Thermal Impedance, θ_{JA}	47.9°C/W (0 lfpm)
Storage Temperature, T_{STG}	-65°C to 150°C

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

TABLE 5A. POWER SUPPLY DC CHARACTERISTICS, $V_{CC} = V_{CCA} = 3.3V \pm 5\%$, $T_A = 0^\circ C$ TO $70^\circ C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{CC}	Core Supply Voltage		3.135	3.3	3.465	V
V_{CCA}	Analog Supply Voltage		3.135	3.3	3.465	V
I_{CC}	Power Supply Current				180	mA
I_{CCA}	Analog Supply Current				15	mA

TABLE 5B. LVCMOS / LVTTTL DC CHARACTERISTICS, $V_{CC} = V_{CCA} = 3.3V \pm 5\%$, $T_A = 0^\circ C$ TO $70^\circ C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{IH}	Input High Voltage		2		$V_{CC} + 0.3$	V
V_{IL}	Input Low Voltage		-0.3		0.8	V
I_{IH}	Input High Current	M8, N0, N1, OE, nP_LOAD, XTAL_SEL	$V_{CC} = V_{IN} = 3.465V$		5	μA
		ADDR_SEL, SDA, SCL, FREF_EXT, VCO_SEL, M0:M7	$V_{CC} = V_{IN} = 3.465V$		150	μA
I_{IL}	Input Low Current	M8, N0, N1, OE, nP_LOAD, XTAL_SEL	$V_{CC} = 3.465V, V_{IN} = 0V$	-150		μA
		ADDR_SEL, SDA, SCL, FREF_EXT, VCO_SEL, M0:M7	$V_{CC} = 3.465V, V_{IN} = 0V$	-5		μA

TABLE 5C. LVPECL DC CHARACTERISTICS, $V_{CC} = V_{CCA} = 3.3V \pm 5\%$, $T_A = 0^\circ C$ TO $70^\circ C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{OH}	Output High Voltage; NOTE 1		$V_{CC} - 1.4$		$V_{CC} - 0.9$	V
V_{OL}	Output Low Voltage; NOTE 1		$V_{CC} - 2.0$		$V_{CC} - 1.7$	V
V_{SWING}	Peak-to-Peak Output Voltage Swing		0.6		1.0	V

NOTE 1: Outputs terminated with 50Ω to $V_{CC} - 2V$.



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TABLE 6. CRYSTAL CHARACTERISTICS

Parameter	Test Conditions	Minimum	Typical	Maximum	Units
Mode of Oscillation		Fundamental			
Frequency		10		25	MHz
Equivalent Series Resistance (ESR)				50	Ω
Shunt Capacitance				7	pF
Drive Level				1	mW

TABLE 7. INPUT FREQUENCY CHARACTERISTICS, $V_{CC} = V_{CCA} = 3.3V \pm 5\%$, $T_A = 0^\circ C$ TO $70^\circ C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f_{IN}	Input Frequency	XTAL; NOTE 1	10		25	MHz
		SCL			10	MHz
		FREF_EXT; NOTE 2	10			MHz

NOTE 1: For the crystal frequency range the M value must be set to achieve the minimum or maximum VCO frequency range of 250MHz to 700MHz. Using the minimum frequency of 10MHz, valid values of M are $200 \leq M \leq 511$.

Using the maximum frequency of 25MHz, valid values of M are $80 \leq M \leq 224$.

NOTE 2: Maximum frequency on FREF_EXT is dependent on the internal M counter limitations. See Application Information Section for recommendations on optimizing the performance using the FREF_EXT input.

TABLE 8. AC CHARACTERISTICS, $V_{CC} = V_{CCA} = 3.3V \pm 5\%$, $T_A = 0^\circ C$ TO $70^\circ C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
F_{OUT}	Output Frequency				700	MHz
$f_{jit(per)}$	Period Jitter, RMS; NOTE 1, 2			3	9	ps
$f_{jit(cc)}$	Cycle-to-Cycle Jitter; NOTE 1, 2			20	40	ps
$t_{sk(o)}$	Output Skew; NOTE 3				80	ps
t_R / t_F	Output Rise/Fall Time	20% to 80%	200		900	ps
t_S	Setup Time	SDA to SCL	20			ns
		M, N to nP_LOAD	20			ns
t_H	Hold Time	SDA to SCL	20			ns
		M, N to nP_LOAD	20			ns
F_M	SSC Modulation Frequency; NOTE 4	XTAL_IN = 16.6667MHz	30	32	33.33	kHz
SSC_{red}	Spectral Reduction; NOTE 4		-7	-10		dB
t_L	PLL Lock Time				10	ms
odc	Output Duty Cycle	$N \neq \div 1$	48		52	%
t_{PW}	Output Pulse Width	$N = \div 1$	$t_{PERIOD}/2 - 275$	$t_{PERIOD}/2$	$t_{PERIOD}/2 + 275$	ps

See Parameter Measurement Information section.

Characterized using a XTAL input.

NOTE 1: This parameter is defined in accordance with JEDEC Standard 65

NOTE 2: See Applications section.

NOTE 3: Defined as skew between outputs at the same supply voltage and with equal load conditions.

Measured from the output differential cross points.

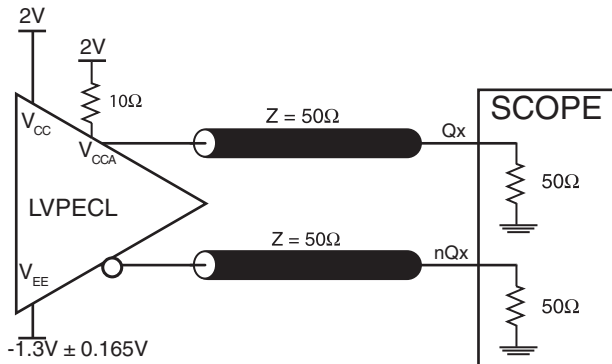
NOTE 4: Spread Spectrum clocking enabled.



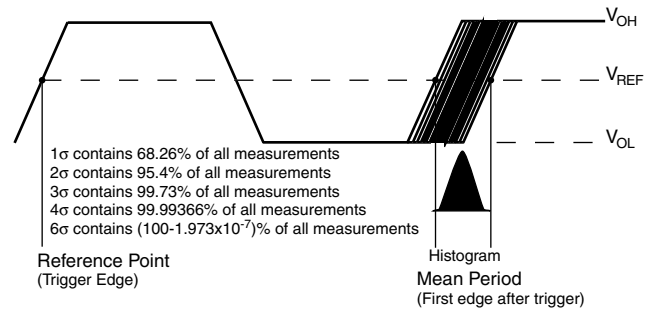
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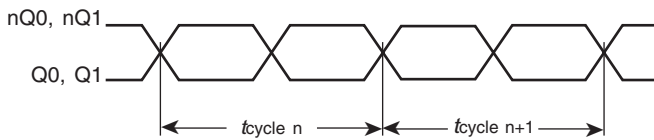
PARAMETER MEASUREMENT INFORMATION



3.3V OUTPUT LOAD AC TEST CIRCUIT



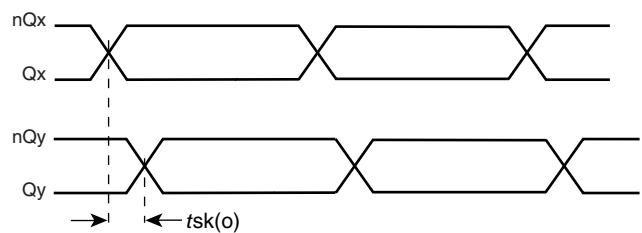
PERIOD JITTER



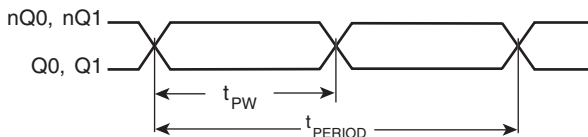
www.DataSheet4U.com

$$t_{jit(cc)} = \frac{t_{cycle\ n} - t_{cycle\ n+1}}{1000\ \text{Cycles}}$$

CYCLE-TO-CYCLE JITTER

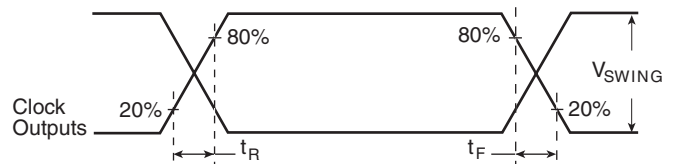


OUTPUT SKEW



$$odc = \frac{t_{PW}}{t_{PERIOD}} \times 100\%$$

OUTPUT DUTY CYCLE/PULSE WIDTH/PERIOD



OUTPUT RISE/FALL TIME



APPLICATION INFORMATION

POWER SUPPLY FILTERING TECHNIQUES

As in any high speed analog circuitry, the power supply pins are vulnerable to random noise. The ICS84330-03 provides separate power supplies to isolate any high switching noise from the outputs to the internal PLL. V_{CC} and V_{CCA} should be individually connected to the power supply plane through vias, and bypass capacitors should be used for each pin. To achieve optimum jitter performance, power supply isolation is required. *Figure 2* illustrates how a 10Ω resistor along with a $10\mu\text{F}$ and a $.01\mu\text{F}$ bypass capacitor should be connected to each V_{CCA} pin. The 10Ω resistor can also be replaced by a ferrite bead.

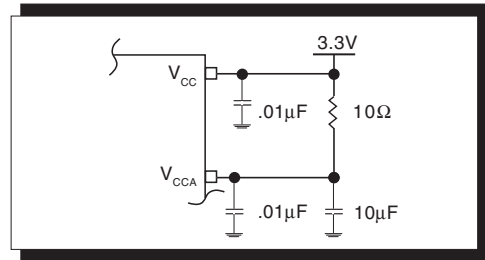


FIGURE 2. POWER SUPPLY FILTERING

RECOMMENDATIONS FOR UNUSED INPUT AND OUTPUT PINS

INPUTS:

SELECT PINS:

All select pins have internal pull-ups and pull-downs; additional resistance is not required but can be added for additional protection. A $1\text{k}\Omega$ resistor can be used.

OUTPUTS:

LVPECL OUTPUT

All unused LVPECL outputs can be left floating. We recommend that there is no trace attached. Both sides of the differential output pair should either be left floating or terminated.

CRYSTAL INPUT INTERFACE

The ICS84330-03 has been characterized with 18pF parallel resonant crystals. The capacitor values, $C1$ and $C2$, shown in *Figure 3* below were determined using an 18pF parallel resonant crystal and were chosen to minimize the ppm error. These same capacitor values will tune any 18pF

parallel resonant crystal over the frequency range and other parameters specified in this data sheet. The optimum $C1$ and $C2$ values can be slightly adjusted for different board layouts.

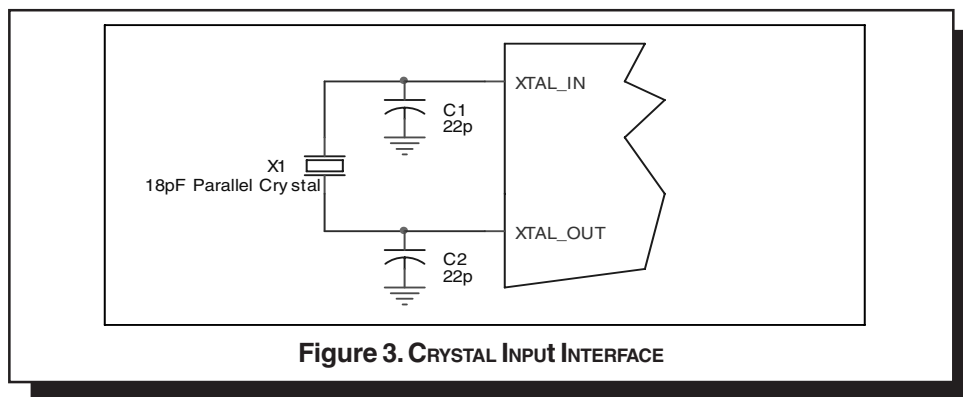


Figure 3. CRYSTAL INPUT INTERFACE



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LVC MOS TO XTAL INTERFACE

The XTAL_IN input can accept a single-ended LVC MOS signal through an AC couple capacitor. A general interface diagram is shown in *Figure 4*. The XTAL_OUT pin can be left floating. The input edge rate can be as slow as 10ns. For LVC MOS inputs, it is recommended that the amplitude be reduced from full swing to half swing in order to prevent signal interference with the power rail and to reduce noise. This configuration requires that the output

impedance of the driver (R_o) plus the series resistance (R_s) equals the transmission line impedance. In addition, matched termination at the crystal input will attenuate the signal in half. This can be done in one of two ways. First, R_1 and R_2 in parallel should equal the transmission line impedance. For most 50Ω applications, R_1 and R_2 can be 100Ω . This can also be accomplished by removing R_1 and making R_2 50Ω .

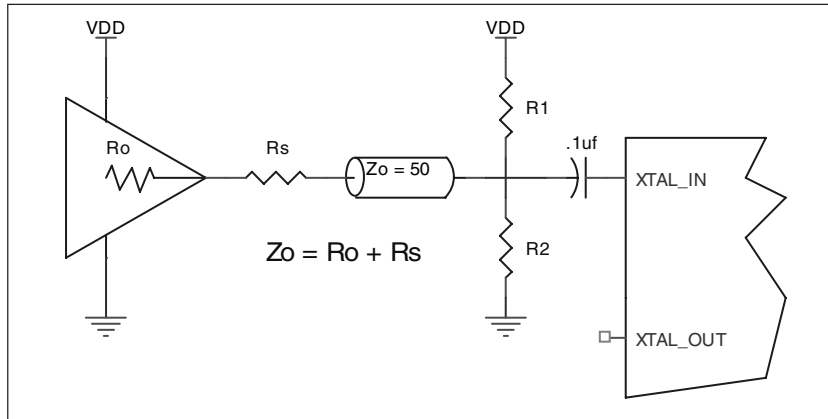


Figure 4. GENERAL DIAGRAM FOR LVC MOS DRIVER TO XTAL INPUT INTERFACE

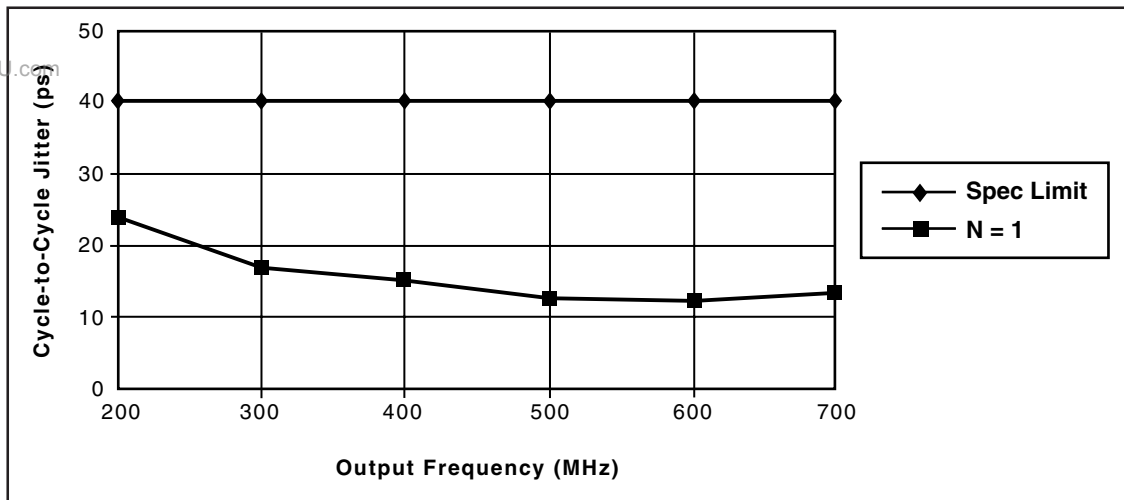


FIGURE 5. CYCLE-TO-CYCLE JITTER VS. f_{OUT} (using a 16MHz XTAL)



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JITTER REDUCTION FOR FREF_EXT SINGLE END INPUT

If the FREF_EXT input is driven by a 3.3V LVCMOS driver, the jitter performance can be improved by reducing the amplitude swing and slowing down the edge rate. Figure 6A shows an amplitude reduction approach for a long trace. The swing will be approximately 0.85V for logic low and 2.5V for logic high

(instead of 0V to 3.3V). Figure 6B shows amplitude reduction approach for a short trace. The circuit shown in Figure 6C reduces amplitude swing and also slows down the edge rate by increasing the resistor value.

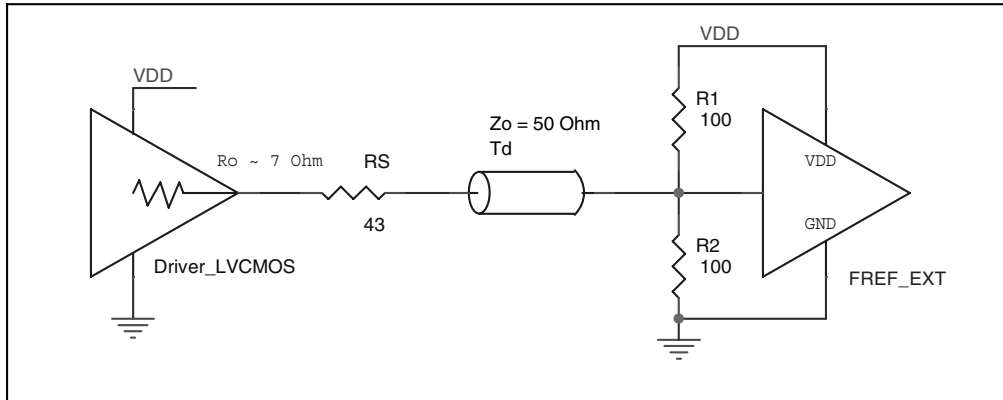


FIGURE 6A. AMPLITUDE REDUCTION FOR A LONG TRACE

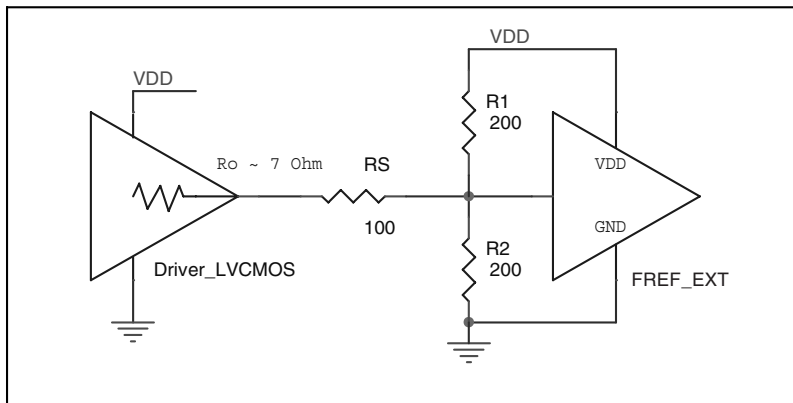


FIGURE 6B. AMPLITUDE REDUCTION FOR A SHORT TRACE

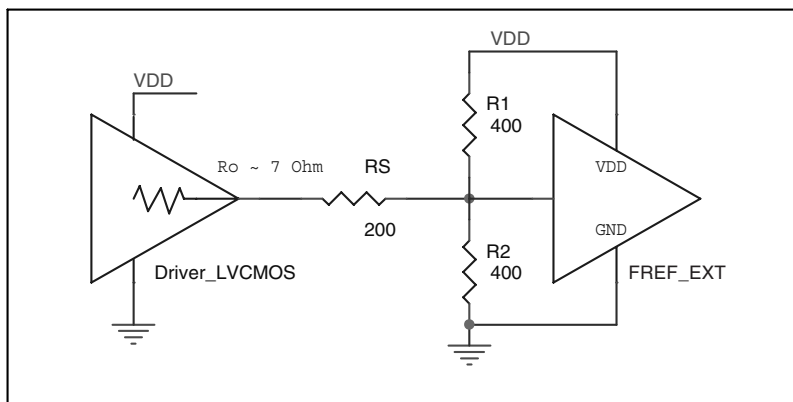


FIGURE 6C. EDGE RATE REDUCTION BY INCREASING THE RESISTOR VALUE

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SPREAD SPECTRUM

Spread-spectrum clocking is a frequency modulation technique for EMI reduction. When spread-spectrum is enabled, a 32kHz triangle waveform is used from the nominal 333MHz clock frequency. An example of a triangle frequency modulation profile is shown in *Figure 7A* below. The ramp profile can be expressed as:

- F_{nom} = Nominal Clock Frequency in Spread OFF mode (333MHz with 16.6667MHz IN)
- F_m = Nominal Modulation Frequency (32kHz)
- δ = Modulation Factor (0.25% down spread)

$$(1 - \delta) f_{nom} + 2 f_m \times \delta \times f_{nom} \times t \text{ when } 0 < t < \frac{1}{2 f_m},$$

$$(1 - \delta) f_{nom} - 2 f_m \times \delta \times f_{nom} \times t \text{ when } \frac{1}{2 f_m} < t < \frac{1}{f_m}$$

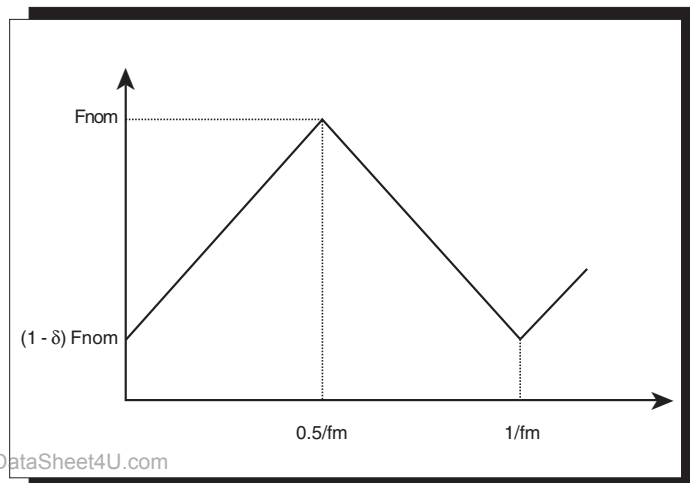


FIGURE 7A. TRIANGLE FREQUENCY MODULATION

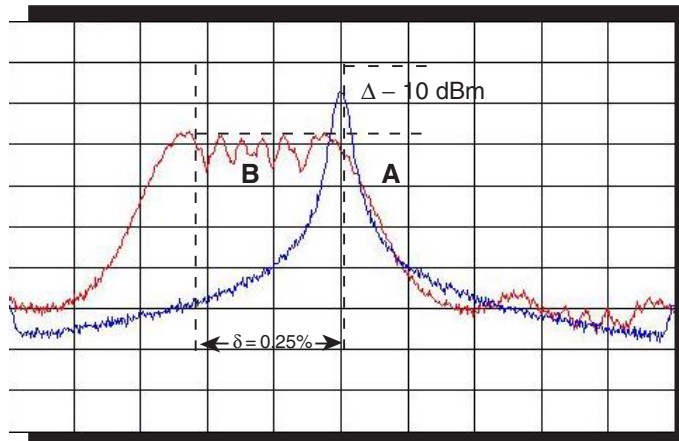


FIGURE 7B. 333MHz CLOCK OUTPUT IN FREQUENCY DOMAIN

- (A) SPREAD-SPECTRUM OFF
(B) SPREAD-SPECTRUM ON



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TERMINATION FOR LVPECL OUTPUTS

The clock layout topology shown below is a typical termination for LVPECL outputs. The two different layouts mentioned are recommended only as guidelines.

FOUT and nFOUT are low impedance follower outputs that generate ECL/LVPECL compatible outputs. Therefore, terminating resistors (DC current path to ground) or current sources must be used for functionality. These outputs are

designed to drive 50Ω transmission lines. Matched impedance techniques should be used to maximize operating frequency and minimize signal distortion. *Figures 8A and 8B* show two different layouts which are recommended only as guidelines. Other suitable clock layouts may exist and it would be recommended that the board designers simulate to guarantee compatibility across all printed circuit and clock component process variations.

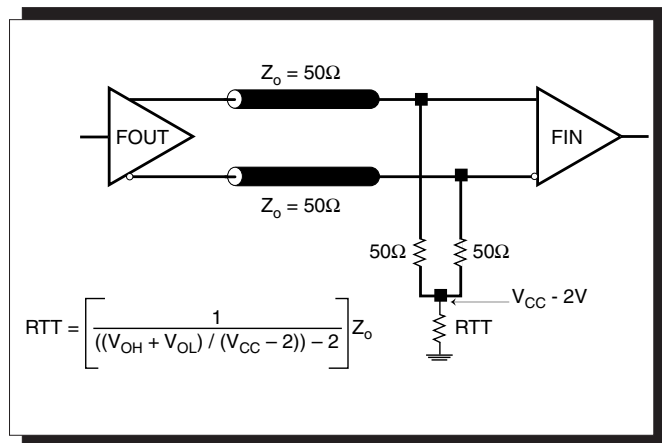


FIGURE 8A. LVPECL OUTPUT TERMINATION

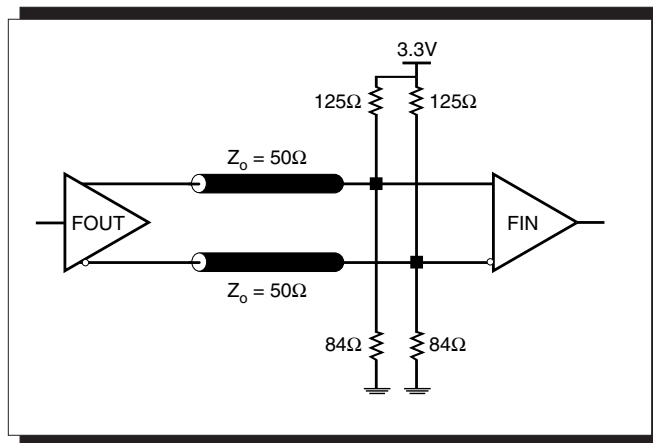


FIGURE 8B. LVPECL OUTPUT TERMINATION



POWER CONSIDERATIONS

This section provides information on power dissipation and junction temperature for the ICS84330-03. Equations and example calculations are also provided.

1. Power Dissipation.

The total power dissipation for the ICS84330-03 is the sum of the core power plus the power dissipated in the load(s). The following is the power dissipation for $V_{CC} = 3.3V + 5\% = 3.465V$, which gives worst case results.

NOTE: Please refer to Section 3 for details on calculating power dissipated in the load.

- Power (core)_{MAX} = $V_{CC_MAX} * I_{EE_MAX} = 3.465V * 180mA = 623.7mW$
- Power (outputs)_{MAX} = **30.2mW/Loaded Output pair**
If all outputs are loaded, the total power is $2 * 30mW = 60mW$

Total Power_{MAX} (3.465V, with all outputs switching) = $623.7 + 60mW = 683.7mW$

2. Junction Temperature.

Junction temperature, T_j , is the temperature at the junction of the bond wire and bond pad and directly affects the reliability of the device. The maximum recommended junction temperature for HiPerClockS™ devices is 125°C.

The equation for T_j is as follows: $T_j = \theta_{JA} * Pd_total + T_A$

T_j = Junction Temperature

θ_{JA} = Junction-to-Ambient Thermal Resistance

Pd_total = Total Device Power Dissipation (example calculation is in section 1 above)

T_A = Ambient Temperature

In order to calculate junction temperature, the appropriate junction-to-ambient thermal resistance θ_{JA} must be used. Assuming a moderate air flow of 200 linear feet per minute and a multi-layer board, the appropriate value is 42.1°C/W per Table 9 below.

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Therefore, T_j for an ambient temperature of 70°C with all outputs switching is:

$$70^\circ C + 0.684W * 42.1^\circ C/W = 98.8^\circ C. \text{ This is well below the limit of } 125^\circ C.$$

This calculation is only an example. T_j will obviously vary depending on the number of loaded outputs, supply voltage, air flow, and the type of board (single layer or multi-layer).

TABLE 9. THERMAL RESISTANCE θ_{JA} FOR 32-PIN LQFP, FORCED CONVECTION

	θ_{JA} by Velocity (Linear Feet per Minute)		
	0	200	500
Single-Layer PCB, JEDEC Standard Test Boards	67.8°C/W	55.9°C/W	50.1°C/W
Multi-Layer PCB, JEDEC Standard Test Boards	47.9°C/W	42.1°C/W	39.4°C/W

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.



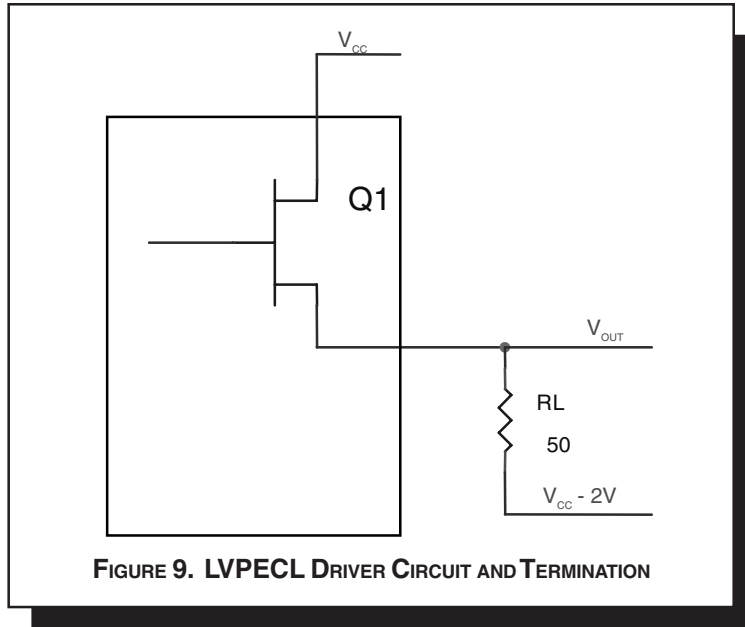
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3. Calculations and Equations.

The purpose of this section is to derive the power dissipated into the load.

LVPECL output driver circuit and termination are shown in the *Figure 9*.



To calculate worst case power dissipation into the load, use the following equations which assume a 50Ω load, and a termination voltage of $V_{CC} - 2V$.

- For logic high, $V_{OUT} = V_{OH_MAX} = V_{CC_MAX} - 0.9V$

$$(V_{CC_MAX} - V_{OH_MAX}) = 0.9V$$

- For logic low, $V_{OUT} = V_{OL_MAX} = V_{CC_MAX} - 1.7V$

$$(V_{CC_MAX} - V_{OL_MAX}) = 1.7V$$

Pd_H is power dissipation when the output drives high.
 Pd_L is the power dissipation when the output drives low.

$$Pd_H = [(V_{OH_MAX} - (V_{CC_MAX} - 2V))/R_L] * (V_{CC_MAX} - V_{OH_MAX}) = [(2V - (V_{CC_MAX} - V_{OH_MAX}))/R_L] * (V_{CC_MAX} - V_{OH_MAX}) = [(2V - 0.9V)/50\Omega] * 0.9V = 19.8mW$$

$$Pd_L = [(V_{OL_MAX} - (V_{CC_MAX} - 2V))/R_L] * (V_{CC_MAX} - V_{OL_MAX}) = [(2V - (V_{CC_MAX} - V_{OL_MAX}))/R_L] * (V_{CC_MAX} - V_{OL_MAX}) = [(2V - 1.7V)/50\Omega] * 1.7V = 10.2mW$$

Total Power Dissipation per output pair = $Pd_H + Pd_L = 30mW$



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RELIABILITY INFORMATION

TABLE 10. θ_{JA} VS. AIR FLOW 32 LEAD LQFP TABLE

θ_{JA} by Velocity (Linear Feet per Minute)			
	0	200	500
Single-Layer PCB, JEDEC Standard Test Boards	67.8°C/W	55.9°C/W	50.1°C/W
Multi-Layer PCB, JEDEC Standard Test Boards	47.9°C/W	42.1°C/W	39.4°C/W

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

TRANSISTOR COUNT

The transistor count for ICS84330-03 is: 9304



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PACKAGE OUTLINE - Y SUFFIX FOR 32 LEAD LQFP

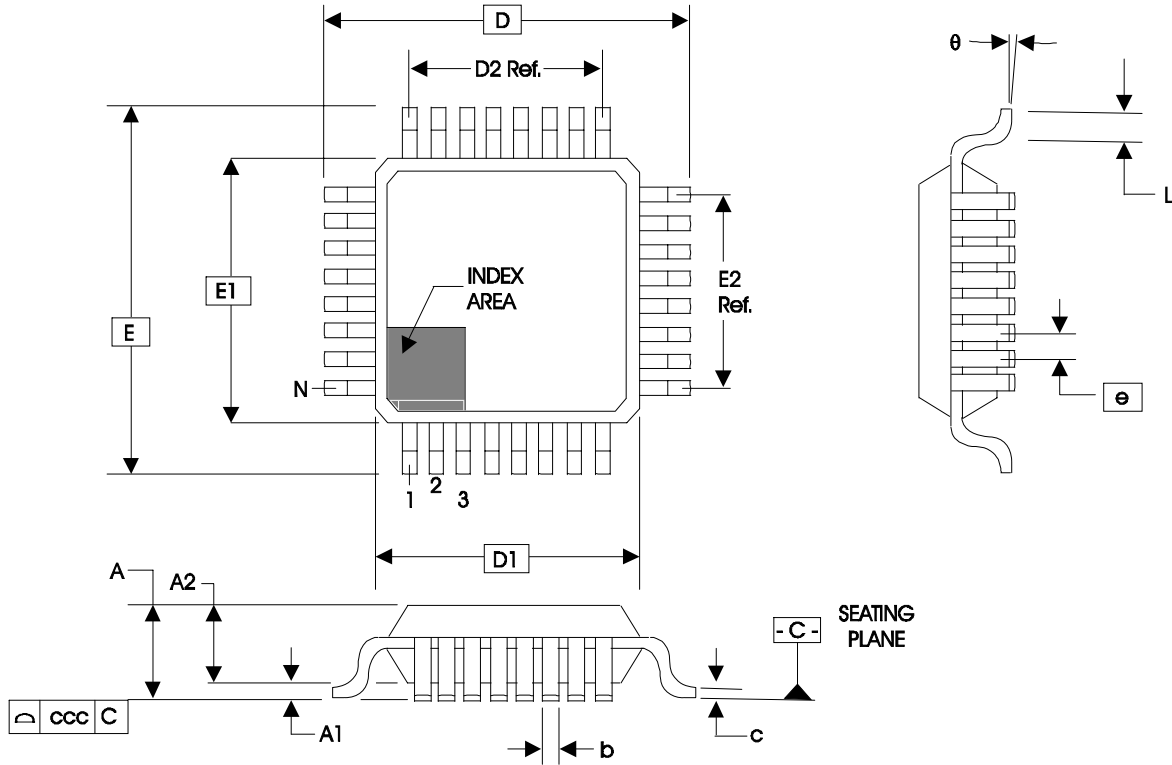


TABLE 11. PACKAGE DIMENSIONS

JEDEC VARIATION ALL DIMENSIONS IN MILLIMETERS			
SYMBOL	BBA		
	MINIMUM	NOMINAL	MAXIMUM
N	32		
A	--	--	1.60
A1	0.05	--	0.15
A2	1.35	1.40	1.45
b	0.30	0.37	0.45
c	0.09	--	0.20
D	9.00 BASIC		
D1	7.00 BASIC		
D2	5.60 Ref.		
E	9.00 BASIC		
E1	7.00 BASIC		
E2	5.60 Ref.		
e	0.80 BASIC		
L	0.45	0.60	0.75
theta	0°	--	7°
ccc	--	--	0.10

Reference Document: JEDEC Publication 95, MS-026



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TABLE 12. ORDERING INFORMATION

Part/Order Number	Marking	Package	Shipping Packaging	Temperature
ICS84330AY-03	ICS84330AY03	32 Lead LQFP	Tray	0°C to 70°C
ICS84330AY-03T	ICS84330AY03	32 Lead LQFP	1000 Tape & Reel	0°C to 70°C
ICS84330AY-03LF	ICS84330A03L	32 Lead "Lead-Free" LQFP	Tray	0°C to 70°C
ICS84330AY-03LFT	ICS84330A03L	32 Lead "Lead-Free" LQFP	1000 Tape & Reel	0°C to 70°C

NOTE: Parts that are ordered with an "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.